

Description

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material-Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over_voltage conditions.

Features

- Max Junction Temperature 175° C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

Mechanical Data

- Case: JEDEC TO-220AC/ITO-220AC/TO-263/TO-252
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

Typical Applications

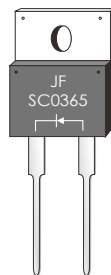
- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

Key Performance And Package Parameters

Type	V _{DC}	I _F	Qc	T _{j,max}	Package
SC0365	650V	3A	8nC	175°C	TO-220AC
SC0365F	650V	3A	8nC	175°C	ITO-220AC
SC0365D2	650V	3A	8nC	175°C	TO-263
SC0365M2	650V	3A	8nC	175°C	TO-252

TO-220AC

SC0365



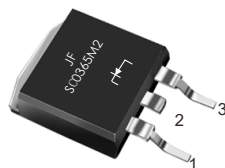
ITO-220AC

SC0365F



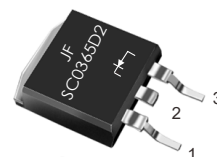
TO-252

SC0365M2



TO-263

SC0365D2



RATINGS AND CHARACTERISTIC OF SC0365XX

Maximum Ratings

(Ratings at 25° C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	650	V
Continuous Forward Current for $R_{th(j-c)}$	I_F	11 $T_c \leq 25^{\circ}C$ 5 $T_c \leq 135^{\circ}C$ 3 $T_c \leq 158^{\circ}C$	A
Non-Repetitive Forward Surge Current (Half-Sine Pulse, $t_p=8.3ms$)	$I_{F,SM}$	30(25°C)	A
I^2t value	$\int i^2t$	3.7 (25°C)	A ² S
Power dissipation for $R_{th(j-c,max)}$ ($T_c=25^{\circ}C$)	P_{tot}	46.8 (TO-220/TO-263/TO-252) 60 (ITO-220)	W
Operating junction temperature range	T_j	-55...175	°C
Storage temperature range	T_{stg}	-55...175	°C

Thermal Characteristics

Parameter	Symbol	ITO-220AC	TO-220AC	TO-263	TO-252	Unit
Diode thermal resistance junction-case	$R_{th(j-c)}$	2.5	3.2	3.2	3.2	°C/W

RATINGS AND CHARACTERISTIC OF SC0365XX

Electrical Characteristics (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
DC blocking voltage	V _{DC}	T _j =25...175°C	650			V
Diode forward voltage	V _F	I _F =3A T _j =25°C		1.4	1.65	V
		I _F =3A T _j =175°C		1.7	2.3	
Reverse current	I _R	V _R =650V T _j =25°C		1	10	uA
		V _R =650V T _j =175°C		5	100	

Dynamic Characteristics(at T_j=25°C,unless otherwise specified)

Parameter	Symbol	conditions	Value			Unit
			min	typ	max	
Total capacitive charge	Q _c	V _R =650V,I _F =3A di/dt=200A/uS T _j =25°C		8		nC
Total capacitance	C	V _R =0V,f=1MHz		180		pF
		V _R =200V,f=1MHz		18		
		V _R =400V,f=1MHz T _j =25°C		15		

RATINGS AND CHARACTERISTIC OF SC0365XX

Typical Performance

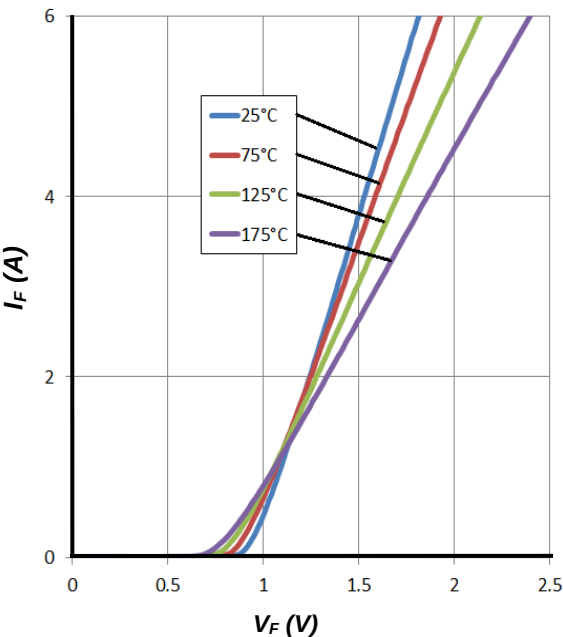


Figure 1. Forward Characteristics

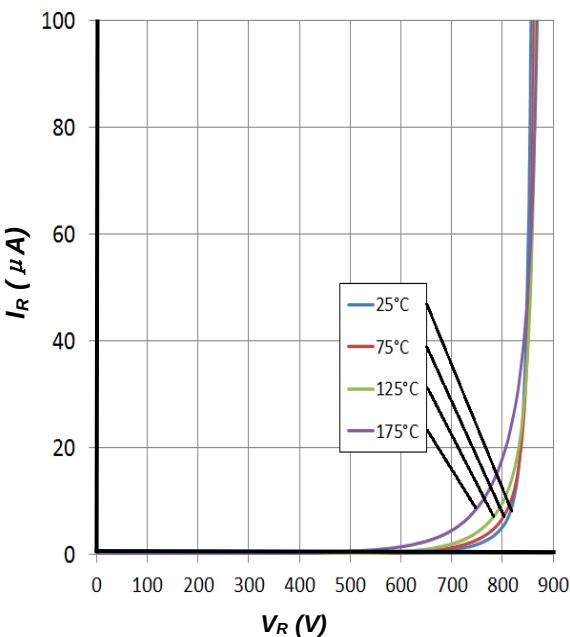


Figure 2. Reverse Characteristics

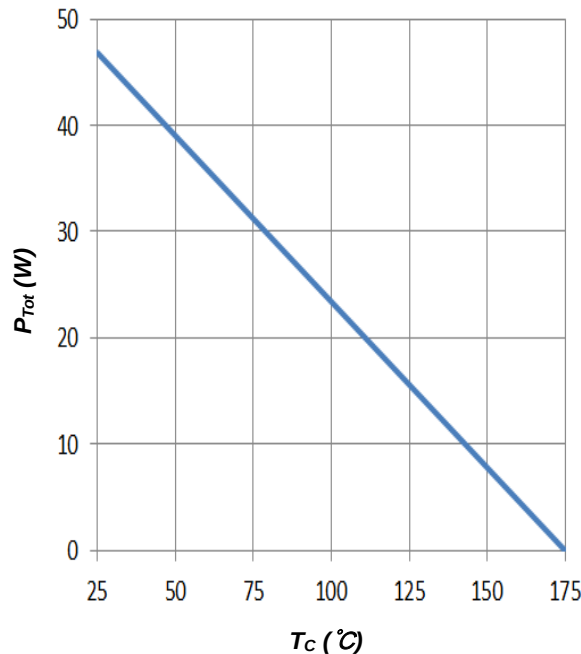


Figure 3. Power Derating
(TO-220/TO-263/TO-252)

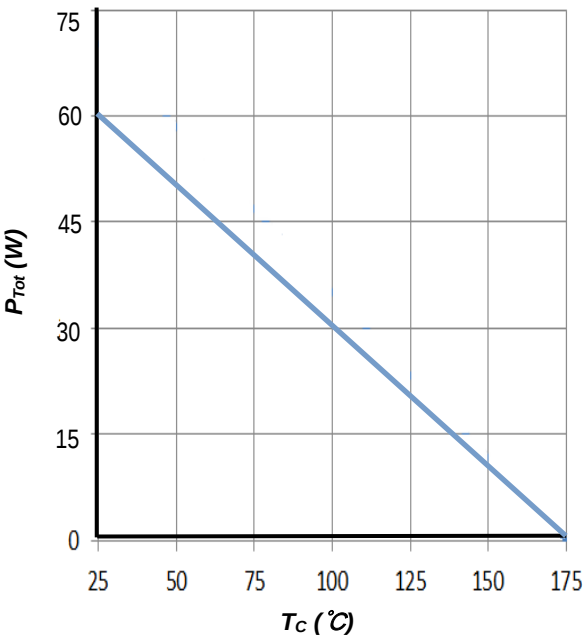


Figure 4. Power Derating
(ITO-220)

RATINGS AND CHARACTERISTIC OF SC0365XX

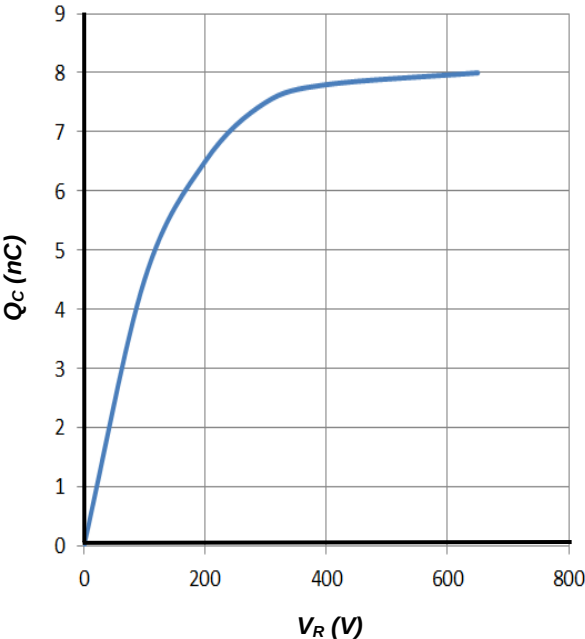


Figure 5. Total Capacitive Charge vs. Reverse Voltage

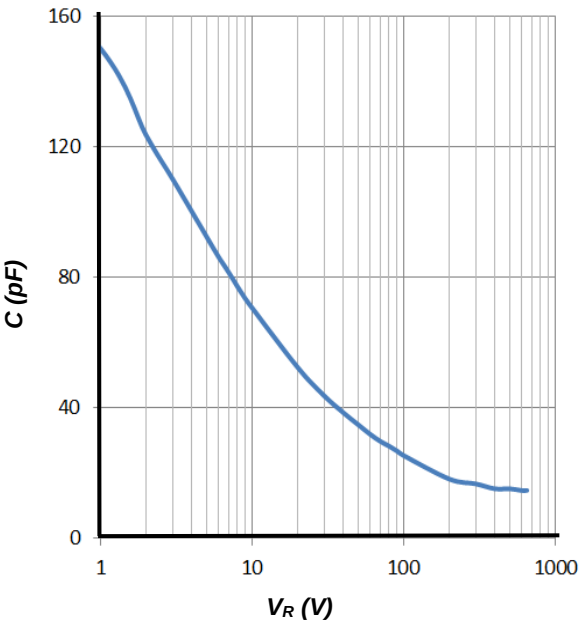
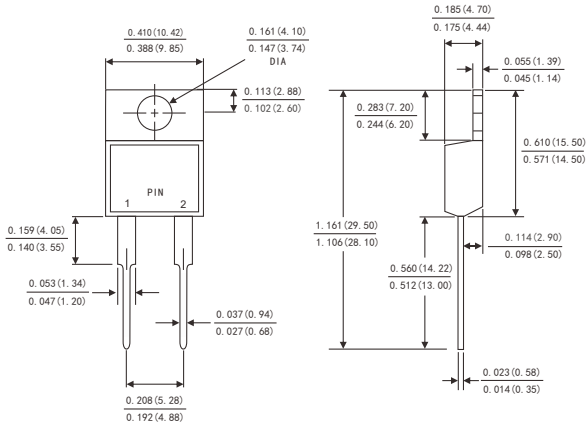


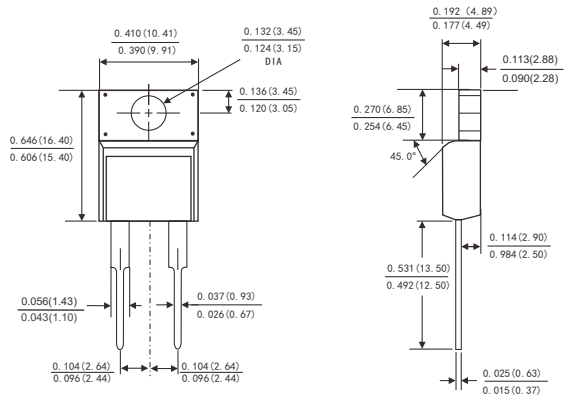
Figure 6 Total Capacitance vs. Reverse Voltage

PACKAGE OUTLINE DIMENSIONS

TO-220AC



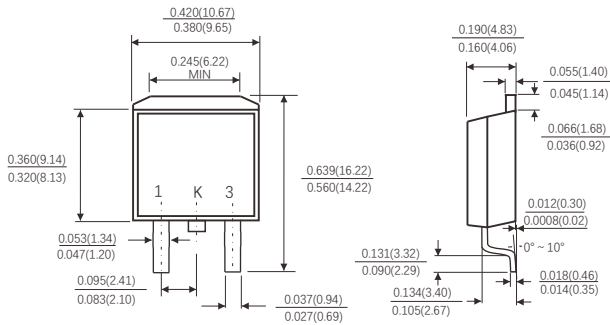
ITO-220AC



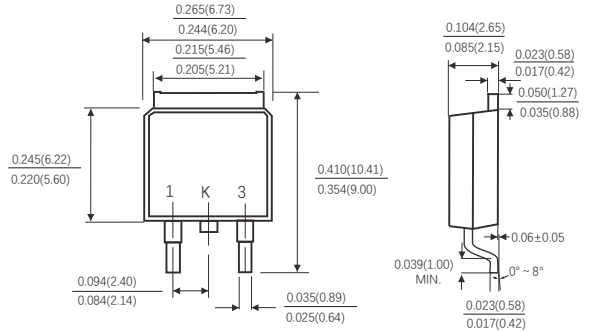
Dimensions in inches and (millimeters)

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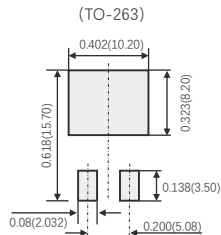
TO-263



TO-252

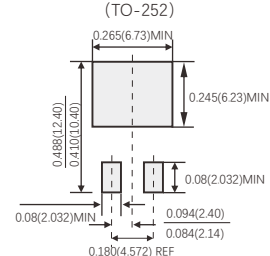


Suggested Pad Layout



(设计者可参考推荐值根据焊接工艺要求自行确定适合的焊盘尺寸)
(Designers can refer to the recommended values according to the manufacturing process requirements to determine the appropriate pad size)

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